



USB2SERA10

24-pin QFN
Case 1897



USB2SERA10 Data Sheet

USB to UART Application Specific IC

Introduction

Freescale Ready Play Solutions integrate a certified function to different applications allowing customers to add features while reducing development cost. This simplifies design cycles and enables scalability in applications and systems.

The USB2SER is a USB to UART bridge controller on a 5 x 5 mm lead free QFN24. It is a simple low cost solution to enable a USB for an embedded system with a UART port, reducing external component counts. It supports USB 2.0 full-speed and TTL RS232 or RS485 UART with options for hardware flow control, Software Flow control (Xon-Xoff), even or odd parity, and stop bits configuration.

Features

- Single chip USB to UART Data Transfer (RS232 or RS485)
- USB specification 2.0 compliant, full speed (12 Mbps)
- User programmable custom baud rates from 300 bps to 115200 bps
- UART supports 8 bit data, 1 or 2 stop bits and odd, even or no parity
- RESUME signal to request a remote wake-up and SUSPEND output to indicate that the device is in suspended mode
- Integrated 3.3 V regulator for a USB IO
- Integrated Power-On-Reset circuit
- Integrated 2 MHz – 48 Mhz clock multiplier PLL
- Supports 2 MHz, 4 MHz, 6 MHz, 8 MHz, 12 MHz, and 16 MHz external crystals with automatic crystal frequency detection
- USB bulk data transfer modes for data communication
- 3 V to 5 V single supply operation
- UHCI / OHCI / EHCI host controller compatible
- Configurable USB VID, PID, and device description strings in the internal flash

- Configurable password to protect the device from additional parameter modifications
- Data formats supported 8 bits data, 1 and 2 stop bits
- Parity odd, even, no parity
- Hardware flow control (RTS / CTS) or Software Xon/Xoff flow control
- RS485_TXEN signal to support RS485
- USB and UART activity pins to indicate communication activity and fail sequences

Drivers support

The USB2SER can act as a CDC standard device that eliminates the need for custom drivers for operation when the flow-control is not needed (only an INF file is required).

For flow control support, COM emulator drivers are available for:

- Windows XP 32-bits and 64-bits versions
- Windows Vista 32-bits and 64-bits versions
- Windows 7 32-bits and 64-bits versions
- Linux Kernel 2.6.34 and higher

Additionally to the drivers, a software configuration tool is provided to customize the Product ID, Vendor ID, Product strings, current consumption parameters and password protection option, to prevent further modifications to the device information. For driver installation and software go to:

The GUI and Driver Installer at www.freescale.com/usb2ser.

Package

USB2SER comes in a compact 5 x 5 mm Pb free RoHS compliant QFN24.



USB Compliant Device

This document contains information on a product under development. Freescale reserves the right to change or discontinue this product without notice.

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USB2SER is fully compliant with the USB 2.0 specification and has been given the USB-IF Test-ID 10006196



Windows Certification

The Windows Logo Program is designed to address the current and future market needs of customers using the Windows platform. The Windows logo signifies the compatibility and reliability of systems and devices with the Windows operating system. It gives customers confidence that your product is thoroughly tested with Microsoft-provided tools and ensures a good user experience.



Product with Windows 7 Logo assures compatibility and reliability. Indicates that our driver has been tested to ensure that they meet Microsoft standards for Windows 7 as well as the quality level that ensures a good Windows experience for end users.



Designed and tested for ease of use, better performance, and enhanced security on PCs running Windows Vista. Certified for Windows Vista products:

- Meet the technical requirements for superior experiences with photos, music, videos, games, and online communications.
- Ensure compatibility with other Certified for Windows Vista products.



Windows XP Certification indicates systems that provide hardware acceleration technology supporting Windows XP Mode. Windows XP Mode allows legacy applications which require Windows XP to run in a virtual machine instance on a Windows 7 PC.

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1 Pins and Connections

1.1 Block diagram

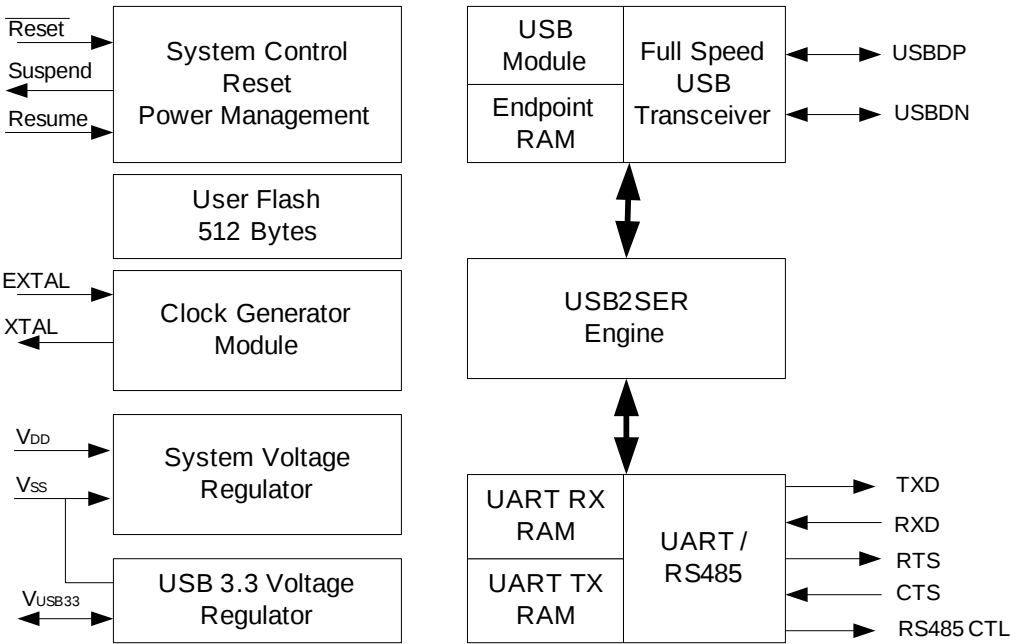


Figure 1. Device block diagram

1.2 Device pin out

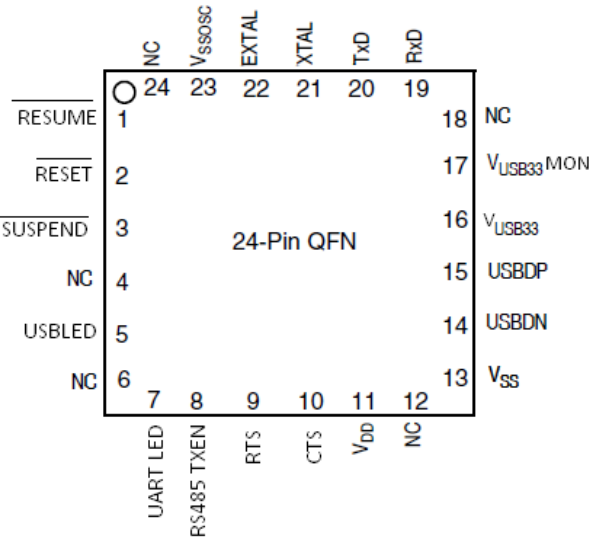


Figure 2. USB2SER — 24-QFN Package

1.3 Recommended system connections

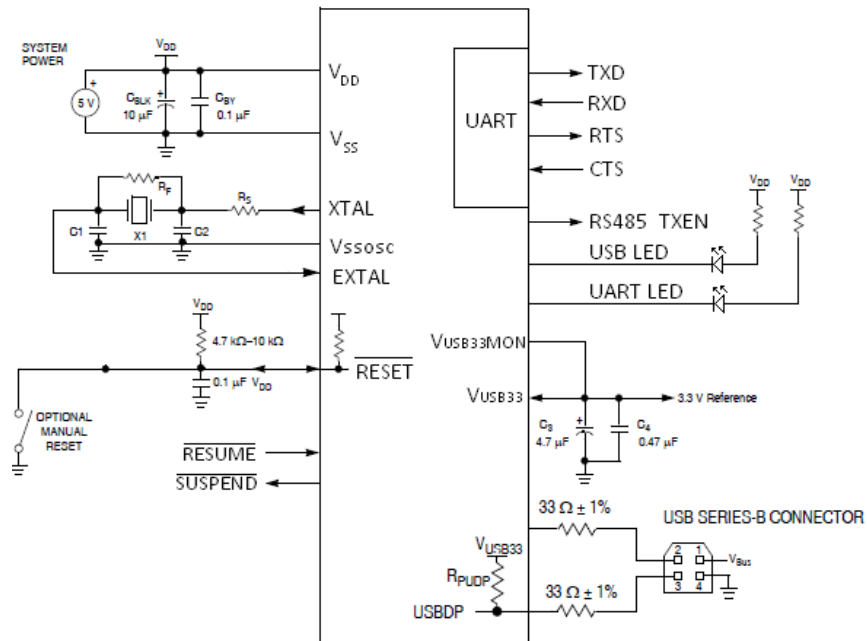


Figure 3. System connections working at 5 V

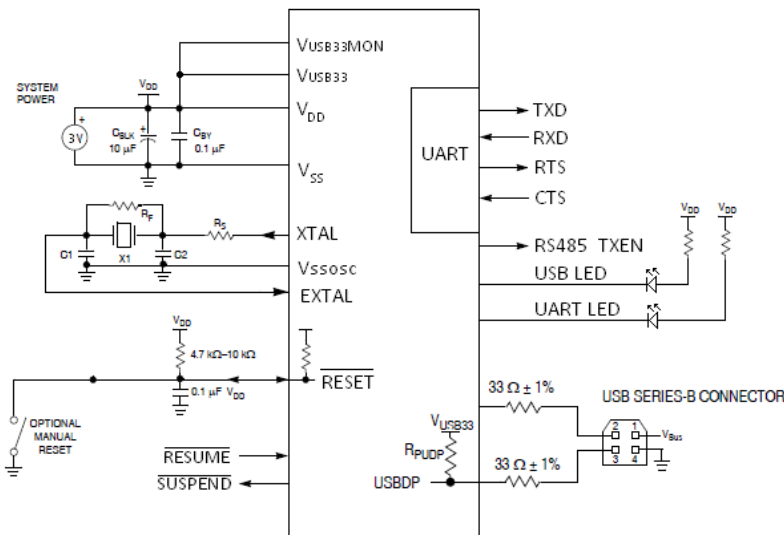


Figure 4. System connections working at 3 V

- ¹ RC filter on RESET is recommended for EMC-sensitive applications.
- ² RPUDP is shown for full-speed USB only. The diagram shows a configuration where the on-chip regulator and RPUDP are enabled. The voltage regulator output is used for RPUDP. RPUDP can optionally be disabled if using an external pullup resistor on USBDP.
- ³ VBUS is a 5.0 V supply from upstream port that can be used for USB operation.
- ⁴ USBDP and USBDN are powered by the 3.3 V regulator.
- ⁵ When using internal VUSB33 as supply, there needs to be an external cap.
- ⁶ When hardware flow control is not being used connect RTS output to CTS input. Avoid leaving these pins floating

1.4 Signals description

Table 1. Signal descriptions

Pin Number	Pin Name	Description
1	/RESUME	Pin to request a remote wake-up
2	/RESET	Reset pin
3	/SUSPEND	Indicates when the device is in suspended mode
4	NC	No connect
5	USB_LED	USB activity LED connection
6	NC	No connect
7	UART_LED	UART Activity LED connection
8	RS485_TXEN	Transmitter control pin for RS485 transceiver
9	RTS	UART request to send connect to CTS when hardware flow control is no being used.
10	CTS	UART clear to send connect to RTS when hardware flow control is no being used.
11	V _{DD}	Supply voltage
12	NC	No connect
13	VSS	0 V ground input
14	USBDN	USB data minus signal
15	USBDP	USB data plus signal
16	V _{USB33}	Bidirectional signal connected to the 3.3 V regulator
17	V _{USB33} MON	USB Internal regulator monitor pin. Connect to V _{USB33}
18	NC	No connect
19	RXD	UART reception pin
20	TXD	UART transmission pin
21	XTAL	XTAL crystal oscillator pin for Pierce oscillator
22	EXTAL	EXTAL crystal oscillator pin for Pierce oscillator
23	VSS_OSC	0 V ground input for the oscillator reference
24	NC	No connect

1.5 Power (V_{DD}, V_{SS}, V_{SSOSC}, V_{USB33})

The V_{DD} and V_{SS} are the primary power supply pins for the USB2SER. This voltage source supplies power to all the I/O buffer circuitry and to an internal voltage regulator.

Typically, application systems have two separate capacitors across the power pins. A 10 μ F tantalum capacitor which provides bulk charge storage for the overall system and a 0.1 μ F ceramic bypass capacitor to suppress high-frequency noise is located as near as possible to the paired V_{DD} and V_{SS} power pins. The USB2SER has a VSSOSC pin. This pin must be connected to the system ground plane or to the primary V_{SS} pin through a low-impedance connection.

If using an external 3.3 V regulator as an input to V_{USB33}, the supply voltage, V_{DD}, must not fall below the input voltage at the V_{USB33} pin. If using the internal 3.3 V regulator, do not connect an external supply to the V_{USB33} pin. In this case, V_{DD}

must fall between 3.9 V and 5.0 V for the internal 3.3 V regulator to operate correctly. The USB2SER uses the VUSB33MON pin to detect V_{DD} used and configure the device accordingly.

1.6 Reset and system initialization

The USB2SER has three reset sources:

- Power-on Reset (POR)
- External Reset Pin (RESET)
- Software update Reset (Soft Reset)

System startup from any reset source starts with the crystal frequency auto-detection that takes 48 ms. After this step, the device initializes the internal PLL to setup the internal clock to 48 MHz which will be used as the reference for the USB and UART to work properly.

After reset from a source different than a POR, the VUSB33MON is configured to discharge the capacitors connected to the VUSB33 voltage when working from a 5V power supply; this adds a 40msec delay to the system startup to determine if the internal voltage regulator has to be enabled.

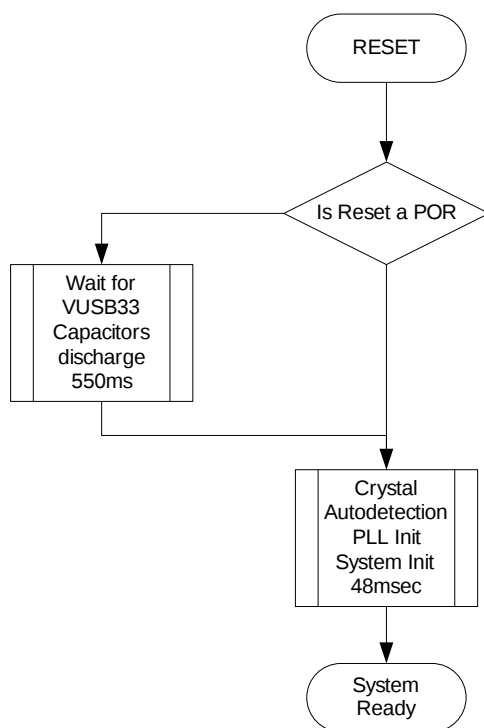


Figure 5. Clock and system initialization

1.7 VID and PID configuration

The USB2SER includes the functionality to modify the VID, PID, Product Description Strings and Power Descriptor Value. The default parameters are:

- VID — 15A2 Hex
- PID — 005A Hex
- Power Descriptor Value for 100 mA
- Manufacturer string — FREESCALE SEMICONDUCTOR INC.
- Product string — USB TO SERIAL

Functional Description

- Serial number string — Version 1.0

Each USB peripheral requires a unique VID/PID combination. Vendor IDs are assigned by the USB-IF. It is possible to use the factory VID/PID combination, only if the Product strings are not modified. In case that the strings are changed, it is necessary to get a different VID/PID combination.

Freescall, as a member of the USB-IF, owns a Vendor ID and manages a database of Product IDs to be used in association with the VID. If a customer of Freescall's USB-enabled products is unable to procure their own VID, apply to use Freescall's VID in association with an assigned PID.

In case the device loses power in the middle of a descriptors configuration process, the default parameters will be loaded to ensure that the part remains functional in all cases. If this happens, the password to protect the device from further modifications will also be reset to the default value which is "FFFFFFFFFFFFFFFF"

2 Functional Description

The USB2SER is a USB2.0 Full Speed (12Mb/s) to the UART (RS232 or RS485) converter. This device integrates an on-chip Full Speed USB 2.0 compatible transceiver, the USB serial interface engine, and an on-chip 3.3 V voltage regulator to a UART communication.

2.1 Crystal frequency auto-detection

The USB2SER supports 2MHz, 4MHz, 6MHz, 8MHz, 12MHz, and 16MHz external crystals connected in a Pierce Oscillator Configuration.

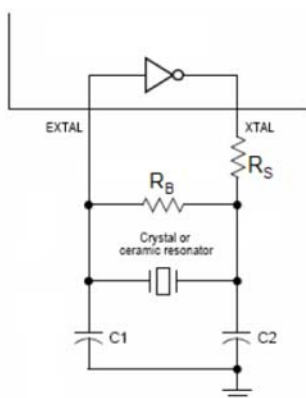


Figure 6. Pierce Oscillator

2.2 Operating errors

In case there is an error with the USB2SER, the device will generate a 2-bit gray sequence using the UART_LED and USB_LED. The following are the possible errors and the device expected behavior:

- For a PLL issue (crystal outside the operating range) the gray sequence changes every 60 ms
- For a USB issue the sequence changes every 200 ms

2.3 RS232 connections

Figure shows the recommended connections to an RS232 transceiver. When interfacing to an RS485 transceiver, the RS485_TXEN controls the transmitter enable signal.

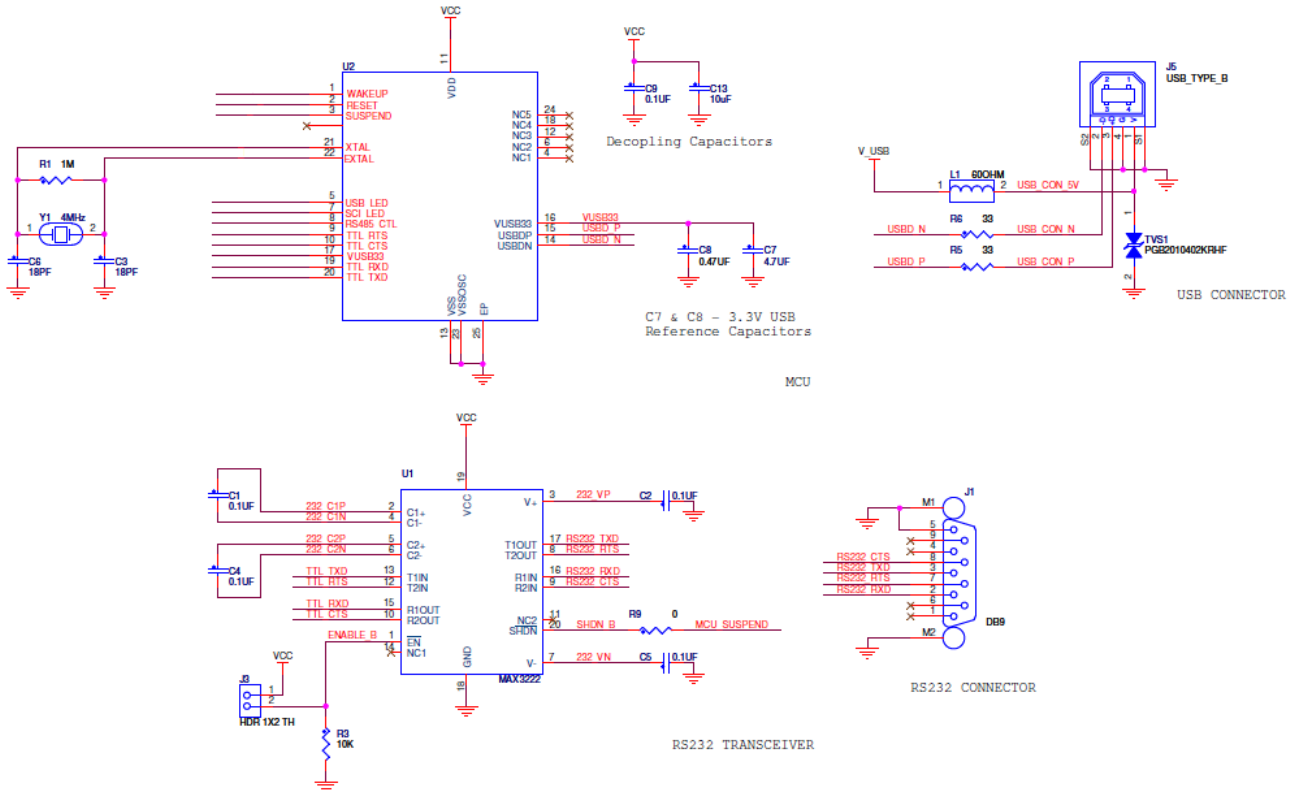


Figure 7. Example schematic using an RS232 transceiver

2.4 UART Baud rates

Baud rate is calculated by generating an internal divisor used to generate the clock for the UART communication module. The following calculation is used to estimate the real baud rate that will be generated by the device:

$$\text{BaudRate} = \frac{24,000,000}{\text{Round}\left(\frac{24,000,000}{\text{DesiredBaudrate} \times 16}\right) \times 16}$$

Where $\text{Round} = \frac{24,000,000}{\left(\frac{24,000,000}{\text{DesiredBaudrate} \times 16}\right)}$ is the closest integer resulting from the division.

After reset the device is automatically configured to communicate at 115,200 bps which is the maximum allowed value.

2.5 Flow control operation

The device works as a standard Communication Device Class (CDC); to add flow control options to this class, the drivers are installed in the operating system to enable this functionality.

When working without any flow control option, it is possible to generate an overflow condition, if the USB host does not request for the data received through the serial interface fast enough. Using any flow control option (hardware or software) eliminates the overflow possibility.

The following formula may be used to determine the amount of time without requesting data to generate the overflow condition:

$$Overflow_Timeout = \frac{BitsPerByte}{BaudRate} * 96$$

Where:

BitsPerByte — 11 for 2 stop bits or any parity option or 10 for 1 stop bit without parity

96 is the Serial buffer size in Bytes

In case the USB host does not request for data before the time out expires and there is no flow control option selected, previously received data will be overwritten with the new received information.

2.6 Operation with commercial terminals for serial communication

Standard terminals for UART communication may have some limitations in the type of data that may be sent/received or some protocol supports.

Known limitations are:

- Binary option must be supported to communicate data that is not standard text
- Communication Protocols (that is, Z modem with Crash recovery, X modem, Y modem, Kermit, and so on) may include a protocol timeout that may not work in baud rates below 2400 bps

When using a standard terminal (HyperTerminal or TeraTerm for example) you must, make sure that the proper configuration is selected to send the desired type of information.

3 Drivers and GUI

The USB2SER can work with the standard Windows driver or with a custom driver for expanded functionality. The Microsoft Windows driver will enable a USB to COM port communication but without Hardware or Software Flow control features from the Host PC to the device. To use this approach, it is possible to copy contents from Appendix C and save it as a file with extension .inf. When the driver is requested the first time after connecting the device it is possible to select this INF file.

Freescale custom drivers for communication allow using any standard terminal or customer software to enable or disable Hardware or Software flow control. The driver also comes with a set of functions to configure Maximum Current consumption through the USB port, Product Strings, Vendor ID and Product ID. Password protects these settings. If any of the product strings or VID/PID is changed, it is necessary to send the product for USB certification if the customer wants to use the USB logo.

3.1 Graphical user interface for product configuration

The GUI provided with the USB2SER is intended to allow the modification of the Bus Power configuration, Vendor ID, Product ID and any of the manufacturer strings. This allows the customization of any product using this product. It is also possible to password protect the device configuration to avoid future modifications after a product release.

Serial to USB Converter

Select Device: COM7

Current Password: FFFFFFFFFFFFFFFF

New Password: FFFFFFFFFFFFFFFF

BusPower (selected) SelfPower

Maximum Current Consumption: 100

Vendor ID: 15A2

Product ID: 005A

Manufacturer String: FREESCALE SEMICONDUCTOR INC.

Product String: USB TO SERIAL

Serial Number String: Version 1.0

READ CHANGE

To configure any or all these settings, once the GUI is open, select the right COM port for the USB2SER.

Serial to USB Converter

Select Device: COM7

Current Password:

New Password:

BusPower (selected) SelfPower

Maximum Current Consumption:

Vendor ID:

Product ID:

Manufacturer String:

Product String:

Serial Number String:

READ CHANGE

To Read the configuration of the USB2SER write the correct password on the current password field and click on the Read button (The Password must be 16 characters long, values allowed are 0–9 and A–F, default password is “FFFFFFFFFFFFFFFF”)

The screenshot shows the 'Serial to USB Converter' window with the following fields and controls:

- Select Device:** A dropdown menu showing 'COM7'.
- Current Password:** A text field containing 'FFFFFFFFFFFFFFF'.
- New Password:** An empty text field.
- Power Mode:** Two radio buttons, 'BusPower' (selected) and 'SelfPower'.
- Maximum Current Consumption:** An empty text field.
- Vendor ID:** An empty text field.
- Product ID:** An empty text field.
- Manufacturer String:** An empty text field.
- Product String:** An empty text field.
- Serial Number String:** An empty text field.
- Buttons:** 'READ' (green) and 'CHANGE' (red) buttons at the bottom.

You should now be able to see the configuration of the USB2SER:

The screenshot shows the 'Serial to USB Converter' window with the following fields and controls:

- Select Device:** A dropdown menu showing 'COM7'.
- Current Password:** A text field containing 'FFFFFFFFFFFFFFF'.
- New Password:** A text field containing 'FFFFFFFFFFFFFFF'.
- Power Mode:** Two radio buttons, 'BusPower' (selected) and 'SelfPower'.
- Maximum Current Consumption:** A text field containing '100'.
- Vendor ID:** A text field containing '15A2'.
- Product ID:** A text field containing '005A'.
- Manufacturer String:** A text field containing 'FREESCALE SEMICONDUCTOR INC.'.
- Product String:** A text field containing 'USB TO SERIAL'.
- Serial Number String:** A text field containing 'Version 1.0'.
- Buttons:** 'READ' (green) and 'CHANGE' (red) buttons at the bottom.

To change any or several parameters from current list, change the desired values and click the Change button.

- For Maximum Current Consumption you can use a value between 20 and 500 and for definition of USB.org, this field only supports even values, value of 0 will cause to change the selection to Self Powered.
- For Vendor ID and Product ID values allowed are 0–9 and A–F
- For Manufacturer String, Product String and Serial Number Strings, any printable ASCII character is valid
- All the fields must have valid information to change the configuration of the USB2SER Bridge
- In case you need to change the current password, you will be able to by writing the new password in the New Password field, then click on the Change button to finish this step.

- Click the Read button with the new password in the Current Password field to confirm that USB2SER bridge setting has been updated according to the previous step.

3.2 Windows driver

Windows driver comes with a product installer. To install it:

Download the latest installer version from www.freescale.com/usb2ser.

To install, double-click on the installation file. A startup window appears.

On the opening window, follow the on-screen instructions

Additional documentation is available for driver usage when developing custom applications in Windows.

3.3 Linux driver

To install the Linux driver follow these simple steps:

1. Unpack the .tar file downloaded
2. In the folder containing the un packed files, check for these four files:
 - cdc-freescale.c
 - cdc-freescale.h
 - Makefile
 - Install.sh
3. Open a console and move to the previously mentioned folder.
 - Change current user to root.
 - \$ sudo su
 - [sudo] password for user:
4. Execute Install script passing as a parameter the name of the host distribution (all lower case).
 - Ubuntu
 - # ./Install.sh ubuntu
 - Fedora
 - # ./Install.sh fedora
 - Red Hat
 - # ./Install.sh redhat

To uninstall

1. Move to CDC driver location.
 - # cd /lib/modules/\$(uname -r)/kernel/drivers/usb/class/
2. Check for backup file.
 - # ls
 - cdc-acm2011.01.27-11.55.54.ko cdc-acm.ko cdc-wdm.ko usbblp.ko usbtmc.ko

NOTE

The backup name varies because it is created at install time merging the original file name plus the date-time. An example is shown in the upper text.

3. Erase current CDC driver.
 - # rm cdc-acm.ko
4. Rename backup file.
 - # mv cdc-acm2011.01.27-11.55.54.ko cdc-acm.ko

Appendix A Electrical Characteristics

This chapter contains electrical and timing specifications.

A.1 Parameter Classification

The electrical parameters shown in this supplement are guaranteed by various methods. To give the customer a better understanding, the following classification is used and the parameters are tagged accordingly in the tables where appropriate:

Table A-1. Parameter classifications

P	Those parameters are guaranteed during production testing on each individual device.
C	Those parameters are achieved by the design characterization by measuring a statistically relevant sample size across process variations.
T	Those parameters are achieved by design characterization on a small sample size from typical devices under typical conditions unless otherwise noted. All values shown in the typical column are within this category.
D	Those parameters are derived mainly from simulations.

NOTE

The above classifications are used in the column labeled C in applicable tables of this data sheet.

A.2 Absolute Maximum Ratings

Absolute maximum ratings are only stress ratings. Functional operation at maximum is not guaranteed. Stress beyond the limits specified in [Table A-2](#) may affect the device reliability or cause permanent damage to the device. For functional operating conditions, refer to the remaining tables in this section.

This device contains circuitry protecting against damage due to high static voltage or electrical fields. However, it is advised that normal precautions be taken to avoid application of any voltages higher than the maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (for instance, either V_{SS} or V_{DD}).

Table A-2. Absolute maximum ratings

Rating	Symbol	Value	Unit
Supply voltage	V_{DD}	2.7 to 5.5	V
Input voltage	V_{in}	-0.3 to $V_{DD} + 0.3$	V
Instantaneous maximum current Single pin limit (applies to all port pins) ^{1, 2, 3}	I_D	± 25	mA
Maximum current into V_{DD}	$I_{DD} 120$	mA	
Storage temperature	T_{stg}	-55 to 150 –	°C
Maximum junction temperature	T_J	150 –	°C

1. Input must be current limited to the value specified. To determine the value of the required current-limiting resistor, calculate resistance values for positive (V_{DD}) and negative (V_{SS}) clamp voltages, then use the larger of the two resistance values.
2. All functional non-supply pins are internally clamped to V_{SS} and V_{DD} .

3. Power supply must maintain regulation within operating VDD range during instantaneous and operating maximum current conditions. If positive injection current ($V_{IN} > V_{DD}$) is greater than I_{DD} , the injection current may flow out of VDD and can result in the external power supply going out of regulation. Ensure external VDD load will shunt current greater than maximum injection current. This will be the greatest risk when the MCU is not consuming power. Examples are: if no system clock is present, or if the clock rate is very low which reduces overall power consumption.

A.3 Thermal Characteristics

This section provides information about operating temperature range, power dissipation, and package thermal resistance. Power dissipation on I/O pins is usually small compared to the power dissipation in on-chip logic. It is user-determined rather than being controlled by the MCU design. To take PI/O into account in power calculations, determine the difference between actual pin voltage and V_{SS} or V_{DD} and multiply by the pin current for each I/O pin. Except in cases of unusually high pin current (heavy loads), the difference between pin voltage and V_{SS} or V_{DD} will be very small.

Table A-3. Absolute maximum ratings

Rating	Symbol	Value	Unit
Operating temperature range (packaged)	T_A	T_L to T_H -40 to 85	$^{\circ}\text{C}$
Thermal Resistance ^{1, 2, 3, 4}			
24-pin QFN	θ_{JA}		$^{\circ}\text{C/W}$
1s		92	
2s2p		33	

1. Junction temperature is a function of die size, on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance
2. Junction to Ambient Natural Convection
3. 1s — Single layer board, one signal layer
4. 2s2p — Four layer board, 2 signal and 2 power layers

The average chip-junction temperature (T_J) in $^{\circ}\text{C}$ can be obtained from:

$$T_J = T_A + P_{D^{IqJA}} P_D \times \theta_{JA} \quad \text{Eqn. 1}$$

Where:

T_A — Ambient temperature, $^{\circ}\text{C}$

θ_{JA} — Package thermal resistance, junction-to-ambient, $^{\circ}\text{C/W}$

P_D — $P_{int} + P_{I/O}$, $P_{int} = I_{DD} \times V_{DD}$, Watts — chip internal power

$P_{I/O}$ — Power dissipation on input and output pins — user determined

For most applications, $P_{I/O} \ll P_{int}$ and can be neglected. An approximate relationship between P_D and T_J (if $P_{I/O}$ is neglected) is:

$$P_D = K \div (T_J + 273^{\circ}\text{C}) \quad \text{Eqn. 2}$$

Electrical Characteristics

Solving Equation 1 and Equation 2 for K gives:

$$K = P_D \times (T_A + 273^\circ\text{C}) + JA \times (P_D)^2 \quad \text{Eqn. 3}$$

Where K is a constant pertaining to the particular part. K can be determined from Equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K, the values of P_D and T_J can be obtained by solving Equation 1 and Equation 2 iteratively for any value of T_A .

A.4 Electrostatic Discharge (ESD) Protection Characteristics

Although damage from static discharge is much less common on these devices than on early CMOS circuits, normal handling precautions must be used to avoid exposure to static discharge. Qualification tests are performed to ensure that these devices can withstand exposure to reasonable levels of static without suffering any permanent damage. This device was qualified to AEC-Q100 Rev E. A device is considered to have failed if, after exposure to ESD pulses, the device no longer meets the device specification requirements. Complete DC parametric and functional testing is performed per the applicable device specification at room temperature followed by hot temperature, unless specified otherwise in the device specification.

Table A-4. ESD Protection characteristics

Rating	Symbol	Value	Unit
ESD Target for Machine Model (MM) — MM circuit description	V_{THMM}	200	V
ESD Target for Human Body Model (HBM) — HBM circuit description	V_{THHBM}	2000	V

A.5 DC Characteristics

This section includes information about power supply requirements, I/O pin characteristics, and power supply current in various operating modes.

Table A-5. ESD Protection characteristics

Num	C	Parameter	Symbol	Min	Typical ¹	Max	Unit
1		Operating voltage	—	2.7	—	5.5	V
2	P	Output high voltage 5 V, I _{Load} = –10 mA 3 V, I _{Load} = –3 mA 5 V, I _{Load} = –2 mA 3 V, I _{Load} = –0.4 mA	V_{OH}	$V_{DD} - 1.5$ $V_{DD} - 1.5$ $V_{DD} - 0.8$ $V_{DD} - 0.8$	— — — —	— — — —	V
		Output low voltage — Low drive (PTxDSn = 0) 5 V, I _{Load} = 2 mA 3 V, I _{Load} = 0.6 mA 5 V, I _{Load} = 0.4 mA 3 V, I _{Load} = 0.24 mA	V_{OH}	1.5 1.5 0.8 0.8	— — — —	— — — —	
3	P	Output low voltage — High drive (PTxDSn = 1) 5 V, I _{Load} = 10 mA 3 V, I _{Load} = 3 mA 5 V, I _{Load} = 2 mA 3 V, I _{Load} = 0.4 mA		1.5 1.5 0.8 0.8	— — — —	— — — —	V

Table A-5. ESD Protection characteristics (continued)

4	P	Output high current — Max total I_{OH} for all ports 5 V 3 V	I_{OHT}	— —	— —	100 60	mA
5	P	Output high current — Max total I_{OL} for all ports 5V 3V	I_{OLT}	— —	— —	100 60	mA
6	P	Input high voltage; all digital inputs	V_{IH}	$0.65 \times V_{DD}$	—	—	V
7	P	Input low voltage; all digital inputs	V_{IL}	—	—	$0.35 \times V_{DD}$	
8	P	Input hysteresis; all digital inputs	V_{HYS}	$0.06 \times V_{DD}$	—	—	mV
9	P	Input leakage current; input only pins ¹	$ I_{In} $	—	.01	1	μA
10	P	High Impedance (off-state) leakage current ¹	$ I_{OZ} $	—	.01	1	μA
11	P	Internal pullup resistors ² (Resume pin)	R_{PU}	20	45	65	k
12	C	Internal pullup resistor to USBDP (to V_{USB33}) Idle Transmit	R_{PUPD}	900 1425	— —	1575 3090	k
13	C	Input capacitance; all non-supply pins	C_{IN}	—	—	8	pF

1. Measured with $V_{In} = V_{DD}$ or V_{SS} .

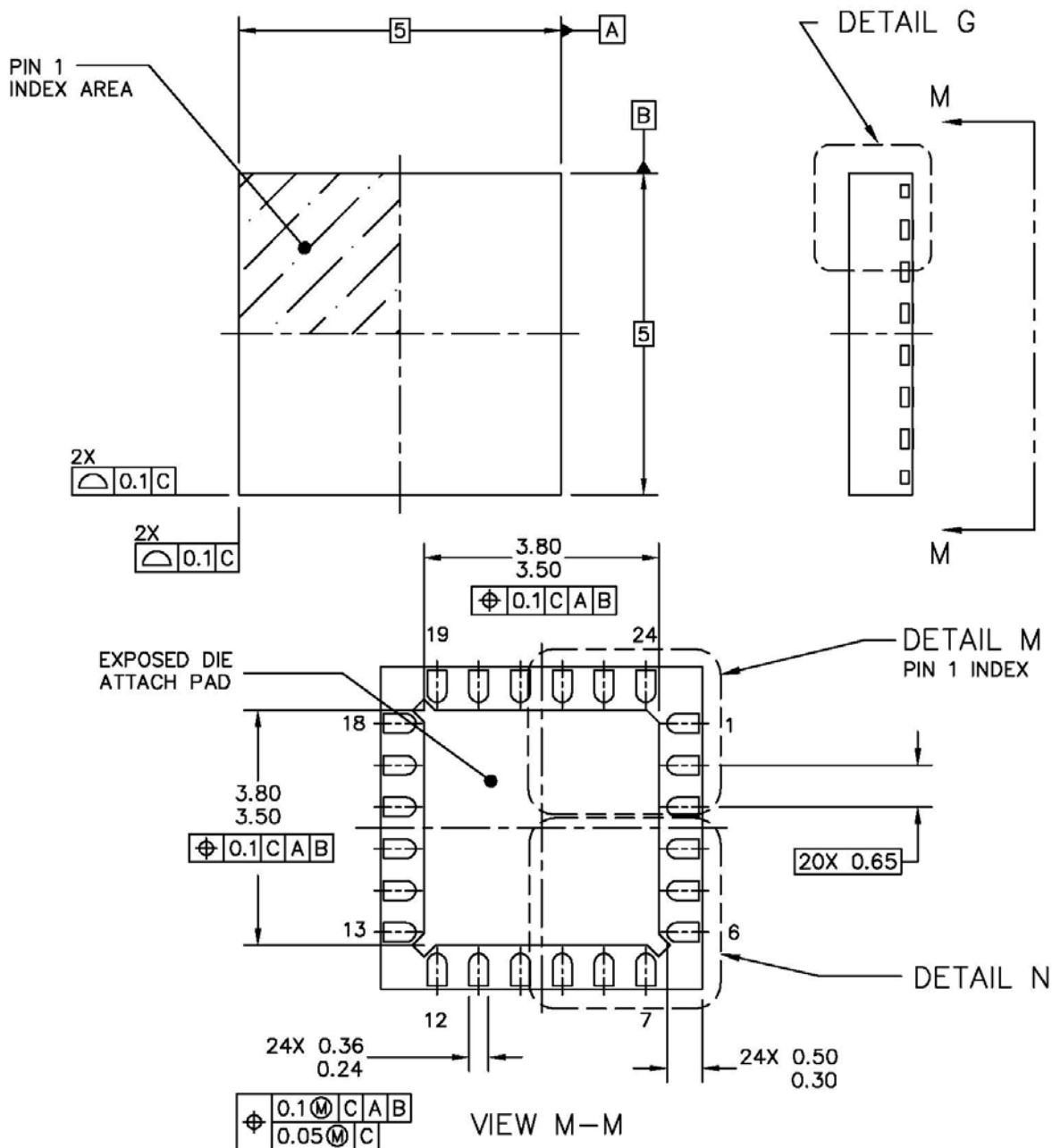
2. Measured with $V_{In} = V_{SS}$.

A.6 Supply Current Characteristics

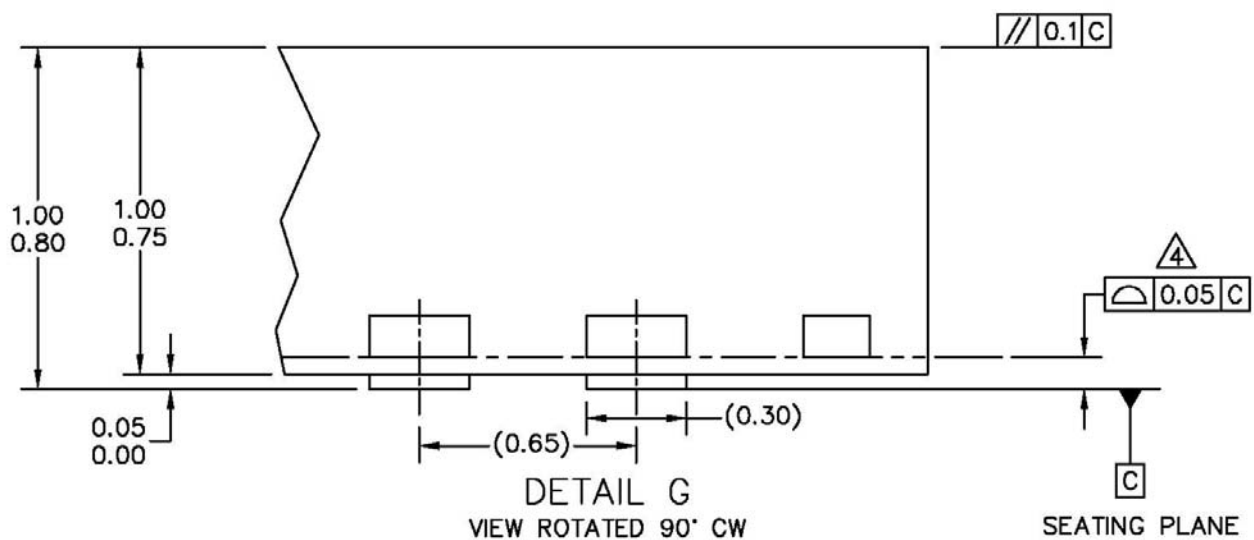
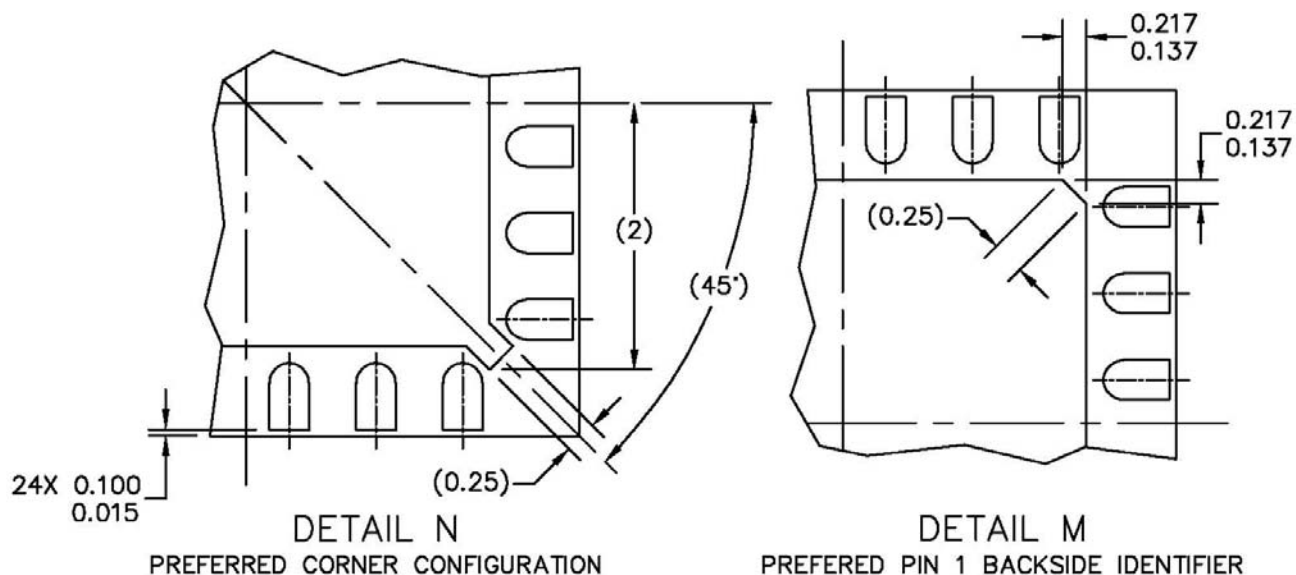
Table A-6. Supply current characteristics

Num	C	Parameter	Symbol	V_{DD} (V)	Typical ¹	Max	Unit
1	P	Run supply current	R_{IDD}	5	19.93	—	mA
				3	18.74	—	mA

Appendix B Package Information



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TITLE: THERMALLY ENHANCED QUAD FLAT NON-LEADED PACKAGE (QFN) 24 TERMINAL, 0.65 PITCH (5 X 5 X 1)		DOCUMENT NO: 98ARL10608D	REV: A
		CASE NUMBER: 1982-02	21 APR 2010
		STANDARD: JEDEC-MO-220 VHHC-1	



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TITLE: THERMALLY ENHANCED QUAD FLAT NON-LEADED PACKAGE (QFN) 24 TERMINAL, 0.65 PITCH (5 X 5 X 1)		DOCUMENT NO: 98ARL10608D		REV: A	
		CASE NUMBER: 1982-02		21 APR 2010	
		STANDARD: JEDEC-MO-220 VHHC-1			

Package Information

NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
3. THE COMPLETE JEDEC DESIGNATOR FOR THIS PACKAGE IS: HF-PQFN.
4.  COPLANARITY APPLIES TO LEADS, CORNER LEADS, AND DIE ATTACH PAD.
5. MIN METAL GAP SHOULD BE 0.2MM.

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TITLE: THERMALLY ENHANCED QUAD FLAT NON-LEADED PACKAGE (QFN) 24 TERMINAL, 0.65 PITCH (5 X 5 X 1)		DOCUMENT NO: 98ARL10608D		REV: A	
		CASE NUMBER: 1982-02		21 APR 2010	
		STANDARD: JEDEC-MO-220 VHHC-1			

Appendix C INF File

```

;-----
;
;                               Freescale Semiconductor INC.
;                               Communication Device Class (CDC) INF File
;-----

[Version]
Signature="$Windows NT$"
Class=Ports
ClassGuid={4D36E978-E325-11CE-BFC1-08002BE10318}
Provider=%MANUFACTURER%
LayoutFile=layout.inf
;CatalogFile=%FILENAME%.cat

DriverVer= 4/24/2009,1.1.2600.1

[Manufacturer]
%MANUFACTURER%=DeviceList,NTamd64

[DestinationDirs]
DefaultDestDir=12

;-----
;
;                               Windows 2000/XP/Vista32 Support
;-----

[DriverInstall.nt]
include=mdmcpq.inf
CopyFiles=DriverCopyFiles.nt
AddReg=DriverInstall.nt.AddReg

[DriverCopyFiles.nt]
usbser.sys,,0x20

[DriverInstall.nt.AddReg]
HKR,,DevLoader,,*ntkern
HKR,,NTMPDriver,,%DRIVERFILENAME%.sys
HKR,,EnumPropPages32,, "MsPorts.dll,SerialPortPropPageProvider"

[DriverInstall.nt.Services]
AddService=usbser, 0x00000002, DriverService.nt

[DriverService.nt]
DisplayName=%SERVICE%
ServiceType=1
StartType=3
ErrorControl=1
ServiceBinary=%12%\%DRIVERFILENAME%.sys

;-----
;
;                               Windows Vista64 Support
;-----

[DriverInstall.NTamd64]
include=mdmcpq.inf
CopyFiles=DriverCopyFiles.NTamd64

```

INF File

AddReg=DriverInstall.NTamd64.AddReg

[DriverCopyFiles.NTamd64]

%DRIVERFILENAME%.sys,,0x20

[DriverInstall.NTamd64.AddReg]

HKR,,DevLoader,,*ntkern

HKR,,NTMPDriver,,%DRIVERFILENAME%.sys

HKR,,EnumPropPages32,,"MsPorts.dll,SerialPortPropPageProvider"

[DriverInstall.NTamd64.Services]

AddService=usbser, 0x00000002, DriverService.NTamd64

[DriverService.NTamd64]

DisplayName=%SERVICE%

ServiceType=1

StartType=3

ErrorControl=1

ServiceBinary=%12%\%DRIVERFILENAME%.sys

;
;-----
; VID/PID Settings
;-----

[SourceDisksFiles]

[SourceDisksNames]

[DeviceList]

%DESCRIPTION%=DriverInstall, USB\VID_15A2&PID_005A

[DeviceList.NTamd64]

%DESCRIPTION%=DriverInstall, USB\VID_15A2&PID_005A

;
;-----
; String Definitions
;-----

[Strings]

FILENAME="FSL_cdc"

DRIVERFILENAME ="usbser"

MANUFACTURER="Freescale Semiconductor"

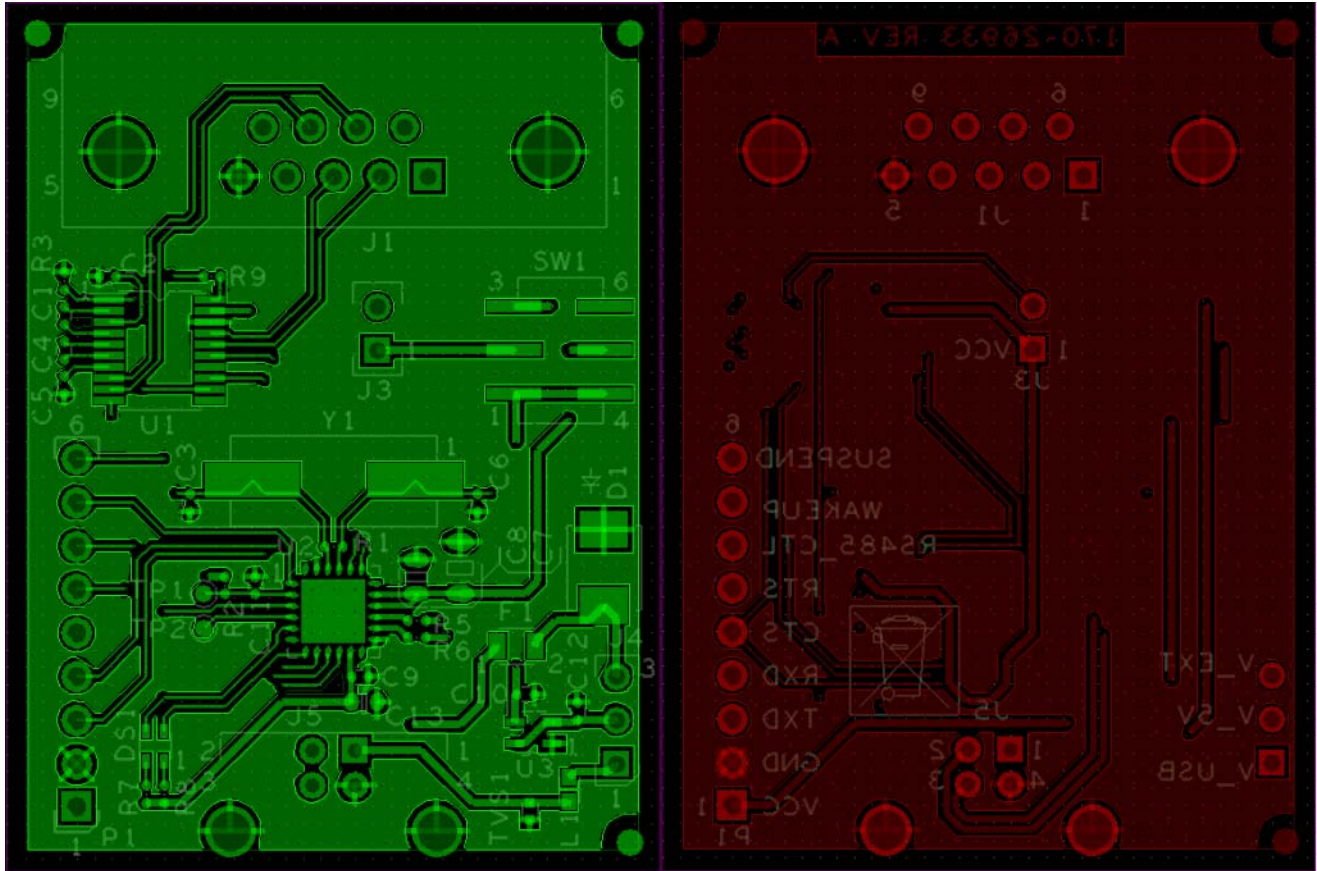
INSTDISK="USB2UART"

DESCRIPTION="Freescale CDC Device"

SERVICE="Virtual Com Driver"

Appendix D USB2SEREVb Layout, Schematics, and BOM

D.1 Board Layout



D.2 Schematics

Table of Contents	
2	NOTES
3	MAIN SCHEMATIC

Revisions			
Rev	Description	Date	Approved
A	ORIGINAL RELEASE	11/04/10	J. CAZAFES
A1	PRELIMINARY RELEASE	02/01/11	J. CAZAFES



Microcontroller Solutions Group
3201 William Cannon Drive West
Austin, TX 78758-5098

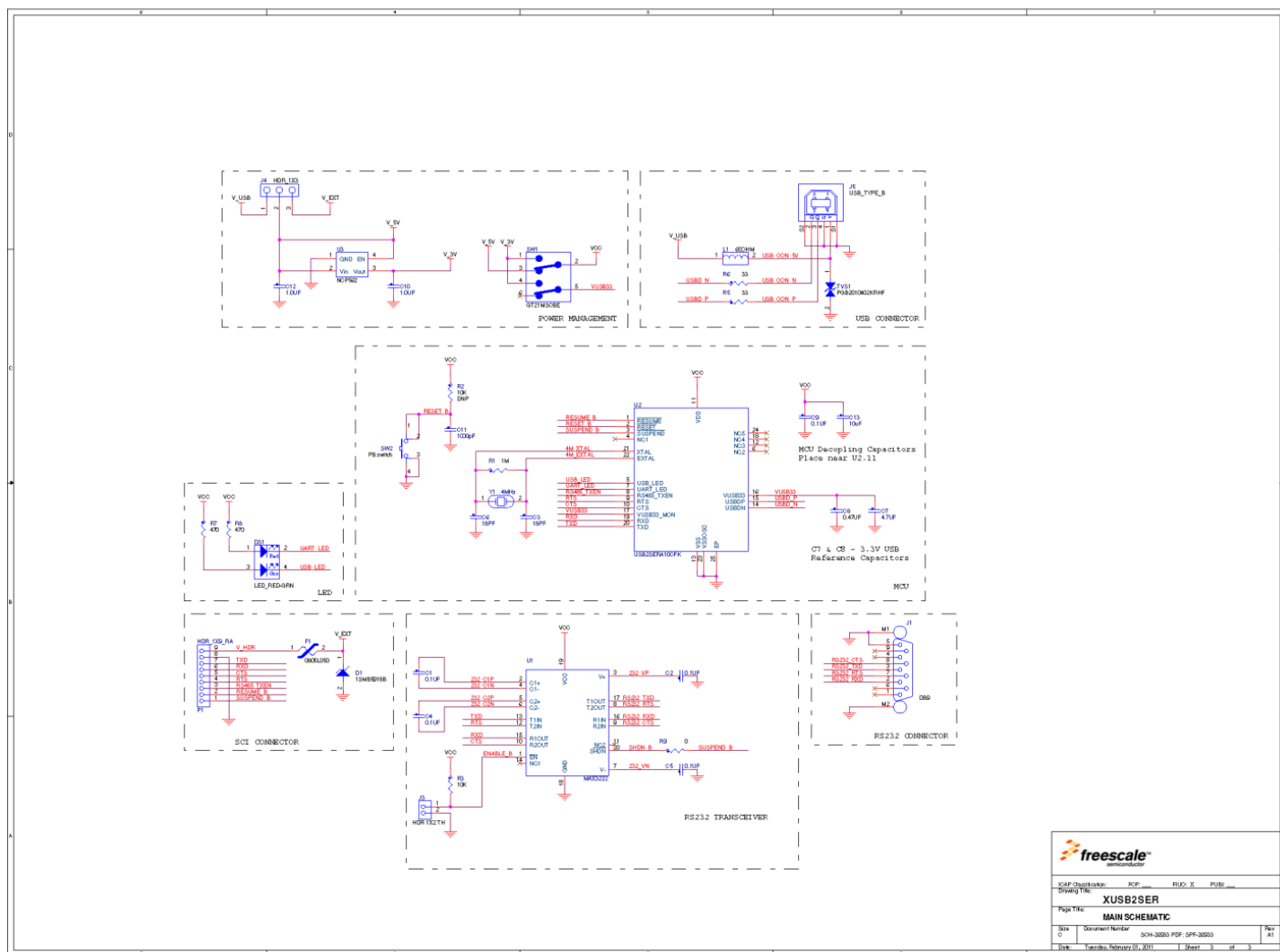
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Designer: A. AHAS	Drawing Title: XUSB2SER	ICAP Classification: ESP	FILED	FILED
Drawn by: A. AHAS	Page Title: TITLE PAGE			
Approved: J. CAZAFES	Rev: 0	Microcontroller Number: SCH-30003 PDF: SPP-30003	Rev: A1	
Date: Tuesday, February 05, 2011	Sheet: 1	of 3		

1. Unless Otherwise Specified:
 All resistors are in ohms, 5%, 1/8 Watt
 All capacitors are in uF, 20%, 50V
 All voltages are DC
 All polarized capacitors are aluminum electrolytic
2. Interrupted lines coded with the same letter or letter combinations are electrically connected.
3. Device type number is for reference only. The number varies with the manufacturer.
4. Special signal usage:
 _B Denotes - Active-Low Signal
 <-> or [] Denotes - Vectored Signals
5. Interpret diagram in accordance with American National Standards Institute specifications, current revision, with the exception of logic block symbology.

	
ICAP-Character: RCP	RUC: X P/B
Drawing Title: XUSB2SER	
Page Title: NOTES	
Size: C	Document Number: SCH-3053 PDF: SPF-3053
Date: November 10, 2011	Sheet: 2 of 3

USB2SREVB Layout, Schematics, and BOM



freescale			
Doc ID: 4420	Doc Number: 4420	Doc Title: XUSB2SER	Doc Version: 1.0
MAIN SCHEMATIC			
Doc ID: 4420	Doc Number: 4420	Doc Title: XUSB2SER	Doc Version: 1.0
Doc ID: 4420	Doc Number: 4420	Doc Title: XUSB2SER	Doc Version: 1.0

D.3 Bill of Materials

Table 2. BOM

Quantity	Description	Reference
1	CAP CER 0.47UF 25V 10% X7R 0805	C8
2	CAP CER 1.0UF 6.3V 10% X5R 0402	C10,C12
5	CAP CER 0.1UF 10V 10% X5R 0402	C1,C2,C4,C5,C9
2	CAP CER 18PF 50V 5% C0G 0402	C3,C6
1	CAP CER 1000PF 50V 5% C0G 0402	C11
1	CAP CER 4.7uF 25V 10% X7R 1206	C7
1	CAP CER 10UF 10V 20% X5R 0603	C13
1	IND FER BEAD 60OHM@100MHZ 500MA -- 0603	L1
1	HDR 1X3 TH 100MIL SP 374H AU	J4
1	HDR 1X2 TH 100MIL SP 339H AU 98L	J3
1	CON 9 DB 0.318 PLUG RA SHLD TH 54MIL SP 494H AU W/ BRD LOCKS	J1
1	CON 2X2 USB_TYPE_B SKT RA SHLD TH 2.5MM SP 453H AU	J5
1	HDR 1X9 TH 100MIL SP 330H SN	P1
2	TEST POINT PAD 40MIL DIA SMT, NO PART TO ORDER	TP1,TP2
1	XTAL 4MHZ -- 18PF 20PPM SMT	Y1
1	IC VREG LDO 3.3V 80MA 6.0V SC82-AB	U3
1	IC USB2SERA10CFK	U2
1	IC XCVR RS232 2 DRV 2 RCV 235KBPS 3.0-5.5V TSSOP20	U1
1	LED RED/GRN DUAL 20MA SMD	DS1
1	RES MF 1.0M 1/16W 1% 0402	R1
2	RES MF 470 OHM 1/16W 5% 0402	R7,R8
1	RES MF ZERO OHM 1/16W 5% 0402	R9
1	RES MF 10K 1/16W 5% 0402	R3
2	RES MF 33.0 OHM 1/16W 1% 0402	R5,R6
1	DIODE ZNR 3W 5.1V SMB	D1
1	DIODE ESD SUPPRESSOR BIDIR -- 12V 0402	TVS1
1	SW DPDT SMT 0.4VA@20VAC/DC	SW1
1	FUSE PTC 0.5A 6V SMT	F1
0	RES MF 10K 1/16W 5% 0402	R2

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USB2SERDS

Rev. 2

10/2012

